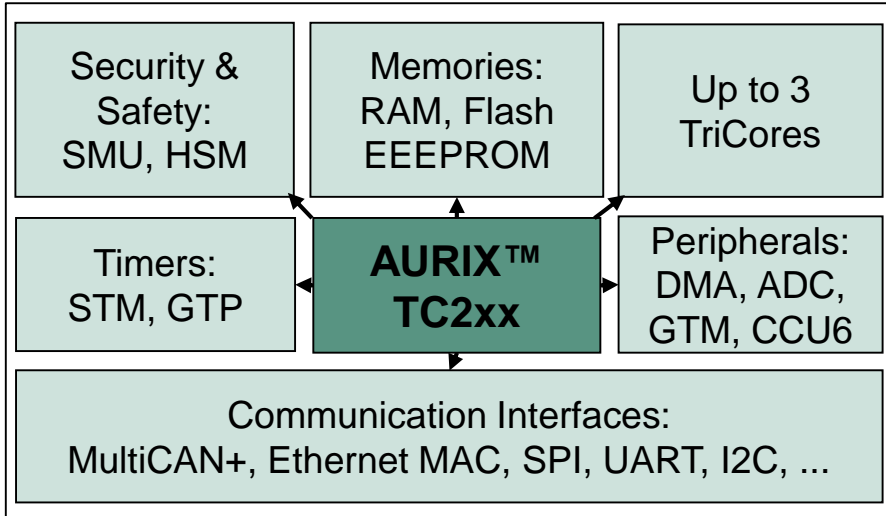


# AURIX™

## System Architecture

AURIX™ Microcontroller Training  
V1.0 2019-03





## Highlights

- > Multicore Microcontroller with embedded Flash
- > TriCore™ (DSP processor) @300 MHz
- > Up to 8 MB Flash, more than 2 MB RAM
- > DMA, HW-FFT, ADC, Ethernet MAC,...

## Key Features

Embedded flash platform for real time applications

Up to 3 TriCore™ with DSP instructions

Rich peripheral set and large RAMs

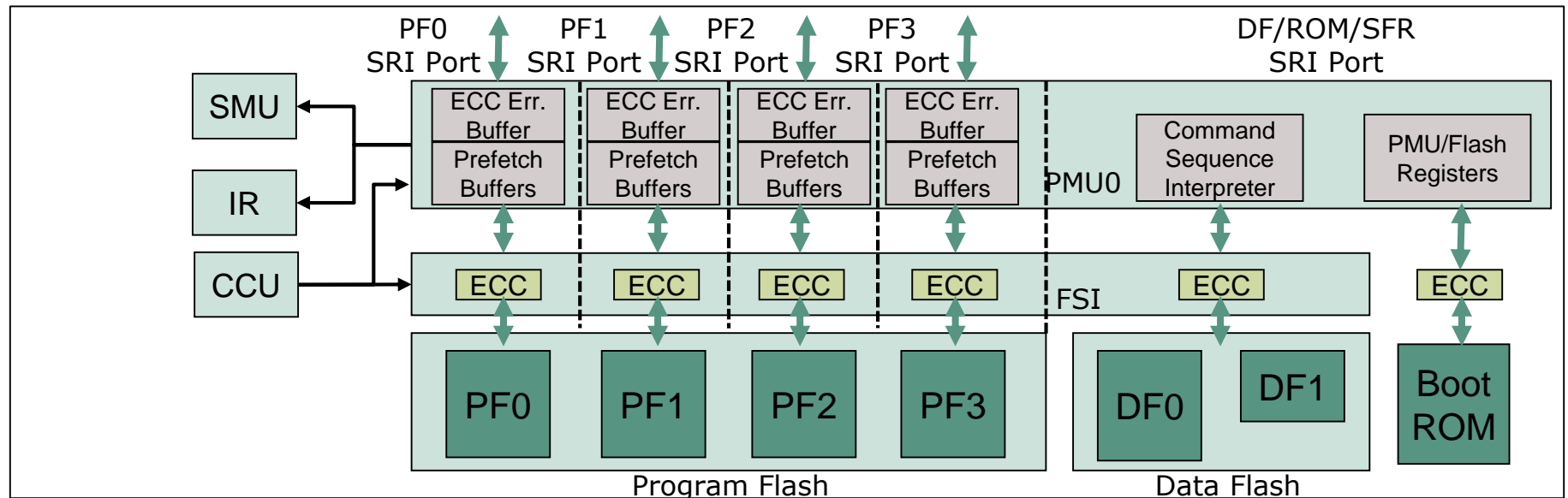
## Customer Benefits

- > Embedded flash allows compact design and fast code execution
- > Enables heavy processing tasks like radar or signal processing applications
- > Reduces the need for external components for cost competitive BOMs

# Embedded flash platform for real time applications

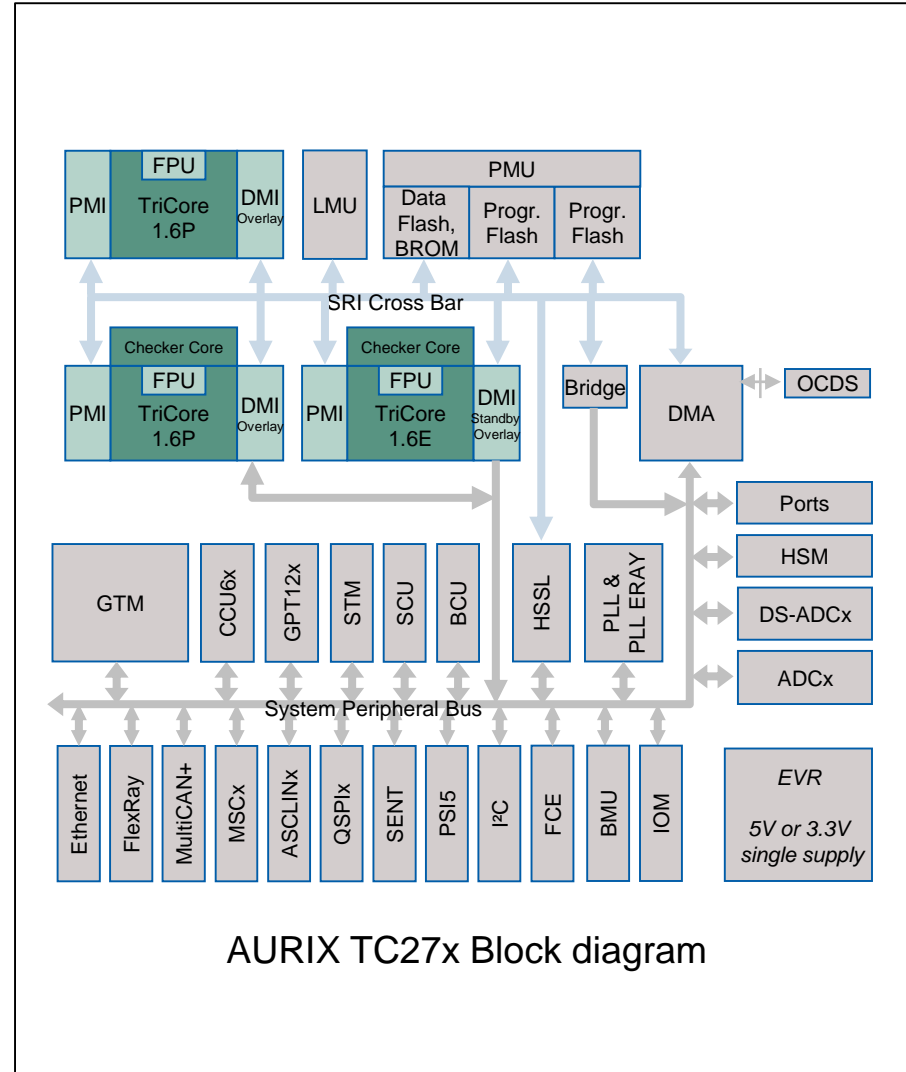
- › All the flash memory is divided in banks (PF0-3 & DF0-1), which are concurrently readable.
- › Each bank has its own Shared Resource Interconnect (SRI) ports, Error Correction Code (ECC) decoders and pre-fetch logic.
- › In case of ECC errors, the Safety Management Unit (SMU) and the Interrupt Router (IR) can be configured to generate errors, respectively interrupts.
- › This embedded flash platform offers a high performance code storage and flexible memory selection, controlled by safety mechanisms.

Note: This is the Flash memory structure of AURIX™ TC29x. For all the other devices, consult the User Manual.



## Up to 3 TriCore™ with DSP instructions

- › The TriCore™ architecture combines three powerful concepts:
  - Microcontroller
  - RISC processor
  - DSP (Digital Signal Processor)
- › **TC 1.6 Efficiency (TC 1.6E):**
  - High **efficiency / low power** architecture
    - **Scalar** Harvard
    - **4 pipeline stages** for up to 200 MHz
  - Identical instruction set as TC1.6P
  - 1.4 DMIPS/MHz
  - Instruction cache
- › **TC 1.6 Performance (TC 1.6P):**
  - High **performance** architecture
    - **Superscalar** Harvard
    - **6 pipeline stages** for up to 300 MHz
  - Identical instruction set as TC1.6E
  - 1.6 DMIPS/MHz
  - Instruction and data cache
- › **32bit Floating Point Unit in all CPUs:**
  - Single precision according to IEEE-754
  - 2 FLOPs per cycle (pipelined)



# Rich peripheral set and large RAMs

## › **Peripherals:**

- ADC: Analog-Digital Converter – 12-bit up to 1 MSPS
- GTM, GPT12 and CCU6: Signal Capture / Compare and PWM generation
- FFT engine: Fourier Transform acceleration
- STM: Timer Module
- DMA: Direct Memory Access Module
- Advanced On – Chip Debug System (OCDS)

## › **Communication Interfaces:**

- QSPI: Advanced SPI interface (Serial Peripheral Interface)
- CAN: Controller Area Network
- Ethernet MAC: Ethernet 100 Mbit/s interface
- I2C: Inter-Integrated Circuit Bus
- EBU: External Bus Unit (32-bit Data, 24-bit Address)

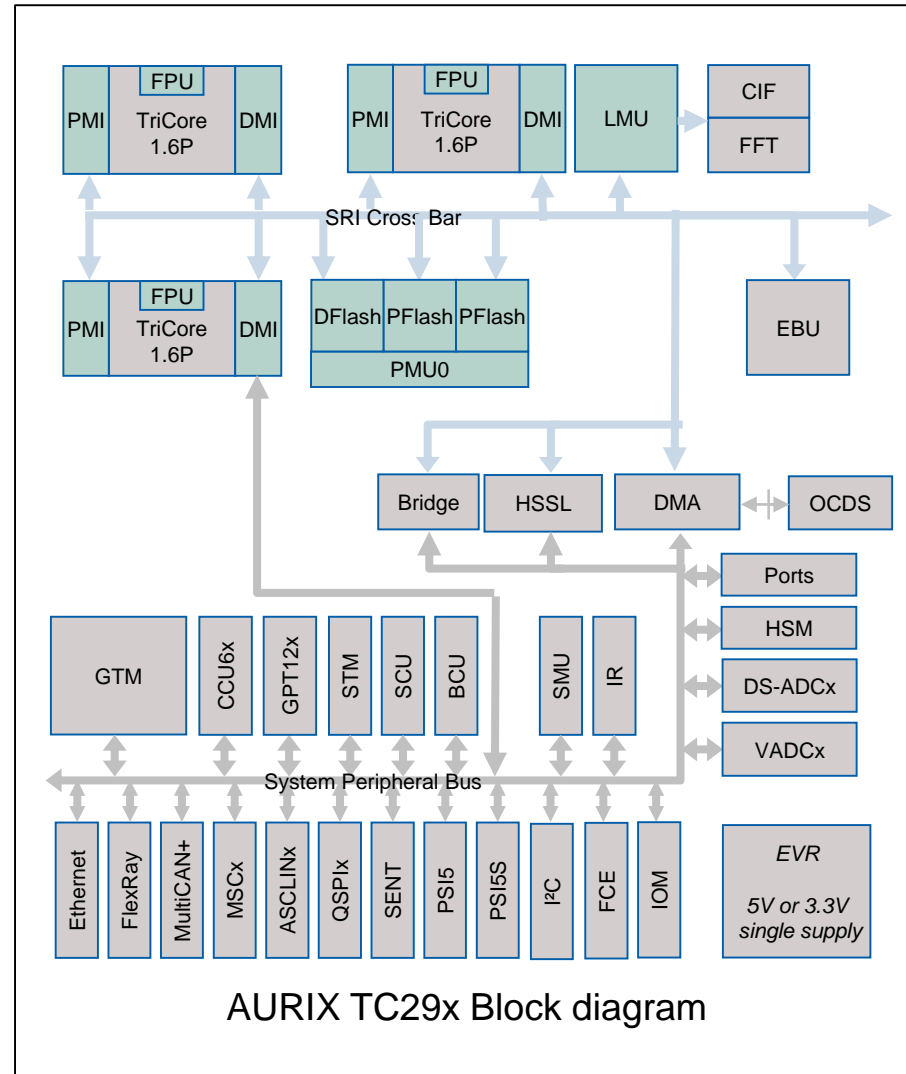
## › **On-Chip Memories:**

- More than 2 MB integrated RAM including CPUs tightly coupled Scratch-Pad RAM
- Up to 8 MB integrated Flash memory with EEPROM Emulation

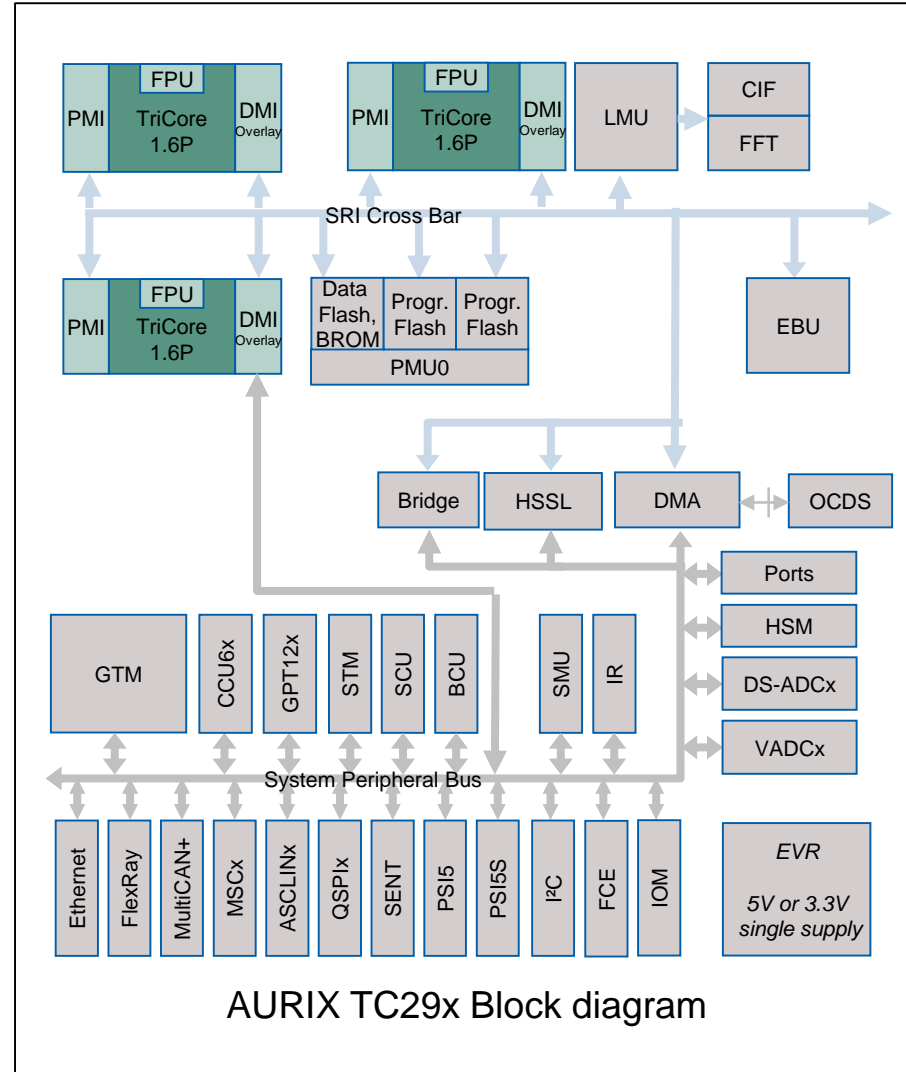
## Rich Peripheral set and large RAMs

AURIX™ Multi-CPU architecture contains:

- > Distributed Scratch-Pad RAMs for data (DSPR) and program (PSPR)
  - Can be accessed by all CPUs
- > CPUs execute code from cached PFlash modules



- › AURIX™ TC2xx combines three powerful technologies within one silicon die, improving power consumption, speed and reducing the costs for embedded applications:
  - Reduced Instruction Set Computing (RISC) processor architecture
  - Digital Signal Processing (DSP) operations and addressing modes
  - On-chip memories and peripherals
- › AURIX™ TC2xx devices are designed to meet the needs of embedded control systems applications, where real-time responsiveness, computational power and data bandwidth are key design elements



### Overview

Car systems like airbag and engine management need to operate in a safe and secure way:

- > Safe: Airbag must not trigger under regular driving conditions
- > Secure: Unauthorized persons must not be able to hack the car's systems

### Advantages

Beside AURIX™ TC2xx versatile set of on-chip peripherals connected to TriCore™ CPUs, the AURIX™ family also offers safety and security modules to deal with critical embedded applications.





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